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# 3.3V, Low Capacitance 16-Bit to 32-Bit, DeMux *NanoSwitch*<sup>TM</sup> with Precharged Outputs

#### **Features**

• R<sub>ON</sub> is 5-ohm (typ.)

• Pullup on B1 and B2 ports

• Low Power:  $50\mu W$  (typ.)

• Industrial Operation Temperature: -40°C to +85°C

• Near-Zero propagation delay

• Switching speed: 4.5ns (max.)

• Channel on capacitance: 14pF (max.)

• V<sub>CC</sub> Operating Range: 3V to +3.6V

• Packaging (Pb-free & Green available):

-56-pin TSSOP(A)

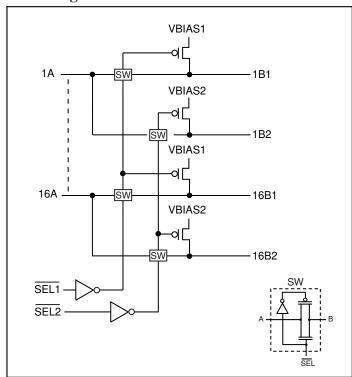
# **Description**

Pericom Semiconductor's PI3B32160 is a 16-bitto 32-bit demultiplexer bus switch. Industry leading advantages include a propagation delay of 250ps, resulting from 5-ohm channel resistance and low I/O capacitance. A port demultiplexes to either 1B and 2B or to both. The switch is bidirectional.

#### **Application**

· Provides PCI Hot Plugging

## **Block Diagram**



Function	SEL1	SEL2
nA to nB1	L	Н
nA to nB2	Н	L
nA to nB1 and nB2	L	L
nB1, nB2 = VBIAS	Н	Н

**Pin Description** 

1B1 <b>戊</b> 1 ○	<b>√</b> / 56 <b>□</b> 1A
2B1 🗖 2	55 <b>þ</b> 1B2
2A 🗖 3	54 🗖 2B2
3B1 🗖 4	53 🗖 3A
4B1 <b>[</b> 5	52 🗖 3B2
4A 🗖 6	51 <b>_</b> 4B2
5B1 <b>[</b> 7	50 🗖 5A
6B1 <b>[</b> 8	49 🗖 5B2
6A 🗖 9	48 🗖 6B2
7B1 <b>[</b> 10	47 🗖 7A
8B1 🗖 11	46 🗖 7B2
8A 🗖 12	45 🗖 8B2
GND 🕻 13	44 🗖 GND
VCC 🕻 14	43 🗖 VCC
9B1 🕻 15	42 🗖 9A
10B1 <b>[</b> 16	41 🗖 9B2
10A 🗖 17	40 🗖 10B2
11B1 🕻 18	39 🗖 11A
12B1 <b>[</b> 19	38 🗖 11B2
12A 🛘 20	37 <b>_</b> 12B2
13B1 <b>[</b> 21	36 🗖 13A
14B1 🕻 22	35 🗖 13B2
14A 🕻 23	34 🗖 14B2
15B1 <b>[</b> 24	33 🗖 15A
16B1 🛮 25	32 <b> </b> 15B2
16A 🛮 26	31 <b>_</b> 16B2
VBIAS1 🛘 27	30 🗖 VBIAS2
SEL1 [ 28	29 🗖 SEL2



#### **Maximum Ratings**

(Above which the useful life may be impaired. For user guidelines, not tested.)

Storage Temperature	65°C to +150°C
Ambient Temperature with Power Applied	40°C to +85°C
Supply Voltage to Ground Potential	0.3V to +4.6V
DC Input Voltage	0.5V to +4.6V
DC Output Current	120mA
Power Dissipation	0.5W

**Note:** Stresses greater than those listed under MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

#### **DC Electrical Characteristics** (Over the Operating Range, T<sub>A</sub>=-40°C to +85°C, V<sub>CC</sub>=3.3V±10%, VBIAS=1.3V to V<sub>CC</sub>)

Parameters	Description	Test Conditions <sup>(1)</sup>		<b>Typ.</b> <sup>(2)</sup>	Max.	Units
V <sub>IH</sub>	Input HIGH Voltage	Guaranteed Logic HIGH Level	2.0			3.7
V <sub>IL</sub>	Input LOW Voltage	Guaranteed Logic LOW Level	-0.5		0.8	V
I <sub>IH</sub>	Input HIGH Current	$V_{CC}=Max., V_{IN}=V_{CC}$			±1	
I <sub>IL</sub>	Input LOW Current	V <sub>CC</sub> =Max., V <sub>IN</sub> =GND			±1	μΑ
I <sub>OZH</sub> <sup>(3)</sup>	High Impedance Output Current	$A = 0 Vor V_{CC} max., VBIAS1 = VBIAS2 = V_{CC} max.$			+1	
V <sub>IK</sub>	Clamp Diode Voltage	V <sub>CC</sub> =Min., I <sub>IN</sub> =-18mA		-0.9	-1.8	V
Ron	Switch On Resistance <sup>(4)</sup>	V <sub>CC</sub> =Min., V <sub>IN</sub> =0.0V,		5	7	
		I <sub>ON</sub> =48mA				Ω
		$V_{CC}$ =Min., $V_{IN}$ =2.4V,		9	15	
		$I_{ON}=15\text{mA}$				

#### **Notes:**

- 1. For Max. or Min. conditions, use appropriate value specified under Electrical Characteristics for the applicable device type.
- 2. Typical values are at  $V_{CC} = 3.3V$ ,  $T_A = 25$ °C ambient and maximum loading.
- 3. Not more than one output should be shorted at one time. Duration of the test should not exceed one second.
- 4. Measured by the voltage drop between A and B pins at indicated current through the switch. ON resistance is determined by the lower of the voltages on the two (A & B) pins.

#### Capacitance ( $T_A = 25$ °C, f = 1 MHz)

Parameters <sup>(1)</sup>	Description	Test Conditions	Тур.	Max.	Units
C <sub>IN</sub>	Input Capacitance	$V_{IN} = 0V$	2.6	3.2	pF
C <sub>OFF</sub>	A Capacitance, Switch Off	$V_{IN} = 0V$	8.0	9.5	pF
$C_{OFF}$	B Capacitance, Switch Off	$V_{IN} = 0V$	4.2	4.7	pF
Con	A/B Capacitance, Switch On	$V_{IN} = 0V$	11	14	pF

#### **Notes:**

1. This parameter is determined by device characterization but is not production tested.



#### **Power Supply Characteristics**

Parameters <sup>(5)</sup>	Description	Test Conditions <sup>(1)</sup>			<b>Typ.</b> <sup>(2)</sup>	Max.	Units
I <sub>CC</sub>	Quiescent Power Supply Current	$V_{CC} = Max.$	$V_{IN} = GND \text{ or } V_{CC}$			20	μА
ΔI <sub>CC</sub>	Supply Current per Input @TTL HIGH	$V_{CC} = Max.$	$V_{IN} = 3.0V^{(3)}$ other pin = $V_{CC}$ or GND			2.5	mA
I <sub>CCD</sub>	Supply Current per Input per MHz <sup>(4)</sup>	V <sub>CC</sub> = Max., A and B Pins Open Control Input Toggling 50% Duty Cycle				0.25	mA/ MHz

#### **Notes:**

- 1. For Max. or Min. conditions, use appropriate value specified under Electrical Characteristics for the applicable device.
- 2. Typical values are at  $V_{CC} = 3.3V$ ,  $+25^{\circ}C$  ambient.
- 3. Per TTL driven input ( $V_{IN} = 3.0V$ , control inputs only); A and B pins do not contribute to  $I_{CC}$ .
- 4. This current applies to the control inputs only and represent the current required to switch internal capacitance at the specified frequency. The A and B inputs generate no significant AC or DC currents as they transition. This parameter is not tested, but is guaranteed by design.
- 5. Values for these conditions are examples of the I<sub>CC</sub> formula. These limits are guaranteed but not tested.

# **Switching Characteristics over Operating Range**

			PI3B32160			
			Com.			
Parameters	Description	Conditions	Min.	Тур.	Max.	Units
t <sub>PLH</sub>	Propagation Delay <sup>(1,2)</sup>	C <sub>L</sub> =50pF	0.25			
$t_{ m PHL}$	A to B	R <sub>L</sub> =500-ohm				
$t_{\rm PZH}$	Bus Enable Time		1.3 4.5		ns	
$t_{\mathrm{PZL}}$	SEL to A,B					
$t_{\mathrm{PHZ}}$	Bus Disable Time		1.3 4.5			
$t_{\rm PLZ}$	SEL to A,B					

#### **Notes:**

- 1. This parameter is guaranteed but not tested on Propagation Delays.
- 2. The bus switch contributes no propagational delay other than the RC delay of the ON resistance of the switch and the load capacitance. The time constant for the switch alone is of the order of 0.25ns for 50pF load. Since this time constant is much smaller than the rise/fall times of typical driving signals, it adds very little propagational delay to the system. Propagational delay of the bus switch when used in a system is determined by the driving circuit on the driving side of the switch and its interaction with the load on the driven side.

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# **Applications Information**

#### **Logic Inputs**

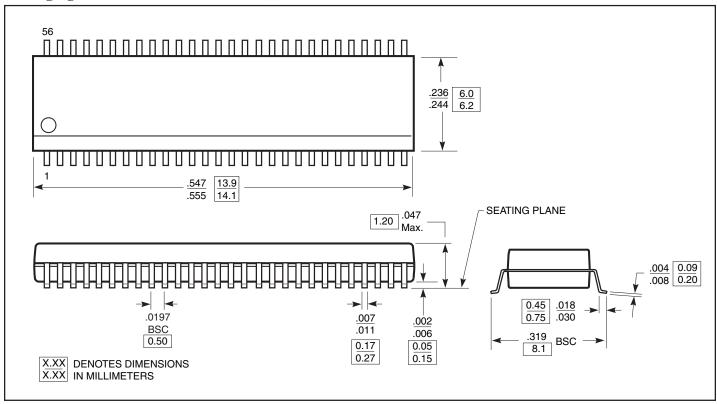
The logic control inputs can be driven up to +3.6V regardless of the supply voltage. For example, given a +3.3V supply, IN may be driven low to 0V and high to 3.6V. Driving IN Rail-to-Rail<sup>®</sup> minimizes power consumption.

#### Power-Supply Sequencing and Hot Plug Information

Proper power-supply sequencing is recommended for all CMOS devices. Always apply  $V_{CC}$  before applying signals to the BIAS voltage pin and the input/output or control pins.

Rail-to-Rail is a registered trademark of Nippon Motorola, Ltd.

#### Packaging Mechanical: 56-Pin TSSOP (A)



#### **Ordering Information**

Ordering Code	Package Code	Package Type
PI3B32160A	A	56-pin TSSOP
PI3B32160AE	A	Pb-free & Green, 56-pin TSSOP

#### **Notes:**

- Thermal characteristics can be found on the company web site at www.pericom.com/packaging/
- E = Pb-free & Green
- Adding an X suffix = Tape/Reel

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